

Electronic Acknowledgement Receipt

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Application Number:	10670291
Confirmation Number:	6427
Title of Invention:	Resist pattern thickening material, process for forming resist pattern, and process for manufacturing semiconductor device
First Named Inventor:	Miwa Kozawa
Customer Number:	38834
Filer:	Stephen G. Adrian/Ayumi Ravencroft
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Information Disclosure Statement (IDS) Filed	031181PTOSB08.pdf	1072204	no	5

Warnings:					
Information:					
2	Foreign Reference	031181RefJP11283910.pdf	1132719	no	22
Warnings:					
Information:					
3	Foreign Reference	031181RefJP2000298356.pdf	1176983	no	24
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6	Foreign Reference	031181RefJP1073927.pdf	1950623	no	30
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7	Foreign Reference	031181RefJP2001109165.pdf	391464	no	8
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8	Foreign Reference	031181RefEP1223470.pdf	438803	no	12
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9	Foreign Reference	031181RefJP200119860.pdf	398776	no	8
Warnings:					
Information:					
10	Foreign Reference	031181RefJP2002023389.pdf	487926	no	10

Warnings:**Information:**

11	Foreign Reference	031181RefJP2002023366.pdf	483542	no	10
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12	NPL Documents	031181RefJPOfficeAction.pdf	49935	no	2
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Total Files Size (in bytes):			9901581		
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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.